



Latest Addition to EcoBind™ Family of Ultra-low Emitting Resin Technologies Provides Savings and Sustainability Benefits to Panelboard Producers

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COLUMBUS, Ohio - (May 22, 2017) - Hexion Inc. ("Hexion" or the "Company") is launching a new EcoBind™ One formaldehyde scavenger product to help particleboard and medium density fiberboard (MDF) producers save on additive costs while meeting CARB Phase 2, EPA TSCA VI and other stringent global emission standards.

The EcoBind One scavenger is utilized with standard urea formaldehyde resins to tie up free formaldehyde and eliminate the majority of emissions during panel production and in finished products. This eliminates the use of urea water, which is a significant cost for particleboard and MDF operations. By eliminating the use of urea additives, the EcoBind One scavenger also enhances a panel's environmental profile.

"Hexion has long been a leader in providing innovative and cost-effective solutions to the panelboard industry," says Mark Alness, Senior Vice President, Americas Forest Products. "The EcoBind One scavenger is another option in our line of EcoBind ultra-low emitting products which customers can choose from, based on the specific performance characteristics they need in their panels and their cost parameters."

The EcoBind One scavenger was specifically designed for the high heat environments typical of MDF and continuous press particleboard production. It can be used with existing equipment and requires no process changes for manufacturers. Hexion's technical support team will adapt and optimize resin packages utilizing EcoBind One scavengers to specific plant conditions and customer requirements.

In addition to the new EcoBind One formaldehyde scavenger resin, the range of EcoBind low-emitting resin technologies for meeting global emission standards such as CARB Phase 2, European EMB and Japanese standards includes:

- * one-part base UF resin systems with very low mole ratios
- * base UF resins with scavengers
- * unique co-reactants

For more information, consult with Hexion - Hall 26, Stand F77 - during LIGNA 2017 in Hanover, Germany, May 22-26, or visit <http://hexion.com/AM/wood-composite-binders/brand/ecobind-resin-technology/>.

About the Company

Based in Columbus, Ohio, Hexion Inc. is a global leader in thermoset resins. Hexion Inc. serves the global wood and industrial markets through a broad range of thermoset technologies, specialty products and technical support for customers in a diverse range of applications and industries. Hexion Inc. is controlled by investment funds affiliated with Apollo Global Management, LLC. Additional information about Hexion Inc. and its products is available at www.hexion.com.

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